

High Performance BGA Cooling Solutions w/ maxiGRIP™ Attachment



ATS Part#: **ATS-53170K-C1-R0**
 Description: maxiGRIP™ HS Assembly-SF-LP, T766, BLACK-ANODIZED

Heat Sink Type: **Straight Fin**
 Heat Sink Attachment: **maxiGRIP**
 Equivalent Part Number: **ATS-53170K-C2-R0 Discontinued**

**Image above is for illustration purpose only.*

Features & Benefits

- High aspect ratio, straight fin heat sinks that are ideal for compact PCB environments
- **maxiGRIP™** attachment applies steady, even pressure to the component and does not require holes in the PCB
- Designed specifically for BGAs and other surface mount packages
- Meets Telcordia GR-63-Core Office Vibration; ETSI 300 019 Transportation Vibration; and MIL-STD-810 Shock Testing and Unpackaged Drop Testing standards
- Comes pre-assembled with high performance, phase changing, thermal interface material
- Designed for low profile components from 1.5 to 2.99mm
- "Keep-Out" Requirements: An "Un-Populated" border zone of 5mm around the component is necessary to facilitate the Installation/Removal of the **maxiGRIP™**. Please refer to the **maxiGRIP™** Keep-Out Guidelines and **maxiGRIP™** Installation/Removal Instructions for further details.

Thermal Performance

AIR VELOCITY		@200 LFM 1.0 M/S	@300 LFM 1.5 M/S	@400 LFM 2.0 M/S	@500 LFM 2.5 M/S	@600 LFM 3.0 M/S	@700 LFM 3.5 M/S	@800 LFM 4.0 M/S
THERMAL RESISTANCE	Unducted Flow	13.10 °C/W	10.43 °C/W	9.02 °C/W	8.09 °C/W	7.41 °C/W	6.90 °C/W	6.48 °C/W
	Ducted Flow	7.80	n/a	n/a	n/a	n/a	n/a	n/a

Product Detail

Schematic Image	Dimension A	Dimension B	Dimension C	Dimension D	TIM	Finish
<p><i>*Image above is for illustration purpose only.</i></p>	17.0 mm	17.0 mm	14.5 mm	mm	T766	BLACK-ANODIZED
<p>Notes:</p> <ul style="list-style-type: none"> • Dimension A and B refer to component size. • Dimension C is the heat sink height from the bottom of the base to the top of the fin field. • ATS-53170K-C2-R0 is the exact heat sink assembly with an equivalent thermal interface material (Saint Gobain C1100F). NOTE: Saint Gobain C1100F is discontinued effective 12/31/10. • Thermal performance data are provided for reference only. Actual performance may vary by application. • ATS reserves the right to update or change its products without notice to improve the design or performance. • ATS certifies that this heat sink assembly is RoHS-6 and REACH compliant. • Optional maxiGRIP™ Installation/Removal Tool Set P/N: MGT170 • Contact ATS to learn about custom options available. 						

For more information, to find a distributor or to place an order, please contact us at 781-769-2800 (North America), sales@qats.com or www.qats.com.

© 2012 Advanced Thermal Solutions, Inc. | 89-27 Access Road | Norwood MA | 02062 | USA



Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Advanced Thermal Solutions:

[MGT190](#) [MGT210](#) [MGT230](#) [MGT250](#) [MGT270](#) [MGT290](#) [MGT300](#) [MGT310](#) [MGT325](#) [MGT330](#) [MGT350](#)
[MGT375](#) [MGT400](#) [MGT425](#) [MGT450](#) [ATS-53170K-C1-R0](#)